

## IS281- 4, IS281- 4GB



### DESCRIPTION

The IS281-4 and IS281-4GB are four channel optical isolators with each channel consists of an infrared emitting diode optically coupled to an NPN silicon photo transistor.

These devices belong to Isocom Compact Range of Optocouplers.

### FEATURES

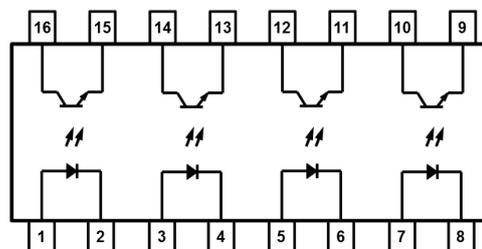
- Half Pitch 1.27mm
- High AC Isolation voltage 3750V<sub>RMS</sub>
- Wide Operating Temperature Range -55°C to 110°C
- Pb Free and RoHS Compliant
- UL Approval E91231 Package Code "THP4"

### APPLICATIONS

- Hybrid Substrates with High Density Mounting
- Industrial System Controllers
- Measuring Instruments
- System Appliances

### ORDER INFORMATION

- Available in Tape and Reel with 2000pcs per reel



1, 3, 5, 7 Anode      9, 11, 13, 15 Emitter  
2, 4, 6, 8 Cathode    10, 12, 14, 16 Collector

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

Forward Current	50mA
Pulse Forward Current	1A
Reverse Voltage	6V
Power dissipation	70mW
Junction Temperature	125°C

#### Output

Output Current	50mA
Collector to Emitter Voltage BV <sub>CEO</sub>	80V
Emitter to Collector Voltage BV <sub>ECO</sub>	7V
Power Dissipation	100mW
Junction Temperature	125°C

#### Total Package

Isolation Voltage	3750V <sub>RMS</sub>
Total Power Dissipation	170mW
Operating Temperature	-55 to 110°C
Storage Temperature	-55 to 150°C
Lead Soldering Temperature (10s)	260°C

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## IS281- 4, IS281- 4GB

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

#### INPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward Voltage	$V_F$	$I_F = 20\text{mA}$		1.2	1.4	V
Reverse Current	$I_R$	$V_R = 4\text{V}$			10	$\mu\text{A}$
Terminal Capacitance	$C_t$	$V_F = 0\text{V}, f = 1\text{KHz}$		30	250	pF

#### OUTPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector-Emitter Breakdown Voltage	$BV_{CEO}$	$I_F = 0, I_C = 0.1\text{mA}$	80			V
Emitter-Collector Breakdown Voltage	$BV_{ECO}$	$I_F = 0, I_E = 10\mu\text{A}$	7			V
Collector-Emitter Dark Current	$I_{CEO}$	$I_F = 0, V_{CE} = 20\text{V}$			100	nA

#### COUPLED

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Current Transfer Ratio	CTR	$I_F = 5\text{mA}, V_{CE} = 5\text{V}$ IS281-4 IS281-4GB	50 100		600 600	%
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F = 8\text{mA}, I_C = 2.4\text{mA}$			0.4	V
Floating Capacitance	$C_f$	$V = 0\text{V}, f = 1\text{MHz}$		0.6	1	pF
Output Rise Time	$t_r$	$V_{CC} = 10\text{V}$ $I_C = 2\text{mA}$ $R_L = 100\Omega$ $f = 100\text{Hz}$		2	18	$\mu\text{s}$
Output Fall Time	$t_f$			3	18	
Turn-On Time	$t_{ON}$			3		
Turn-Off Time	$t_{OFF}$			3		
Turn-On Time	$t_{ON}$	$V_{CC} = 5\text{V}$ $I_F = 16\text{mA}$ $R_L = 1.9\text{k}\Omega$		2		
Turn-Off Time	$t_{OFF}$			40		
Storage Time	$t_s$			25		

#### ISOLATION

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Input to Output Isolation Voltage	$V_{ISO}$	$RH = 40\% - 60\%, t = 1 \text{ min}$ Note 1	3750			$V_{RMS}$
Input to Output Isolation Resistance	$R_{ISO}$	$RH = 40\% - 60\%, V_{IO} = 500\text{V}$ Note 1	$5 \times 10^{10}$	$1 \times 10^{11}$		$\Omega$

Note 1 : Measured with input leads shorted together and output leads shorted together.

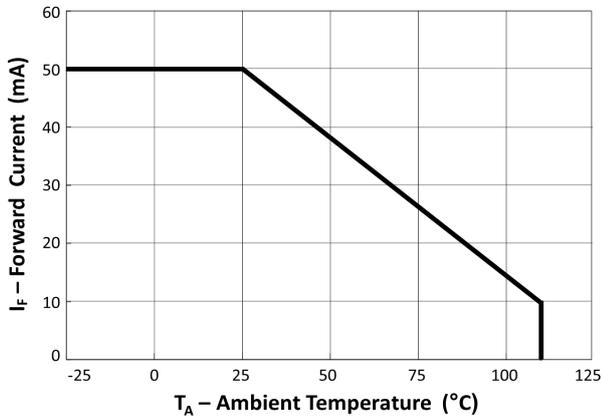


Fig 1 Forward Current vs Ambient Temperature

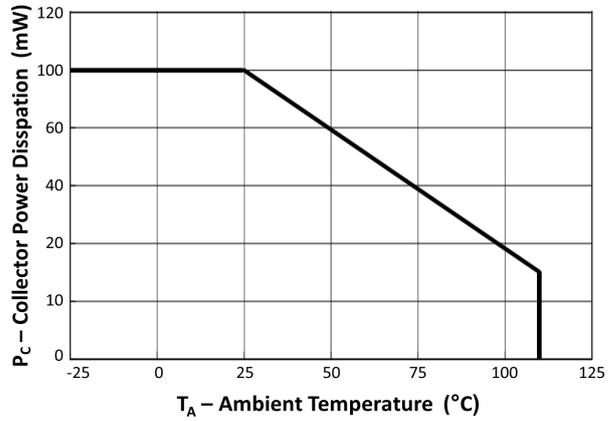


Fig 2 Collector Power Dissipation vs Ambient Temperature

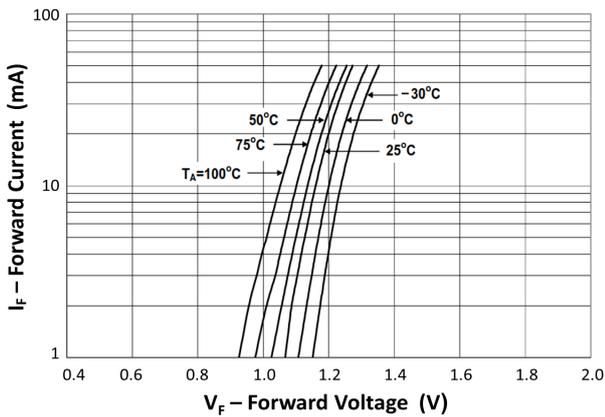


Fig 3 Forward Current vs Forward Voltage

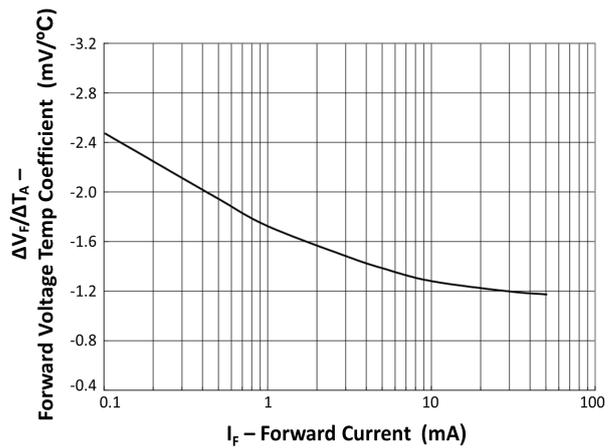


Fig 4 Forward Current Temperature Coefficient vs Forward Current

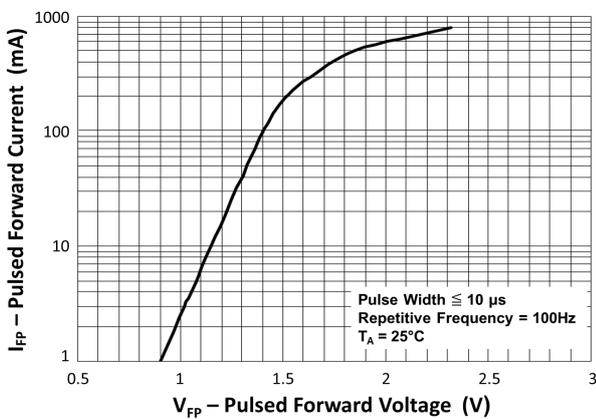


Fig 5 Pulse Forward Current vs Pulse Forward Voltage

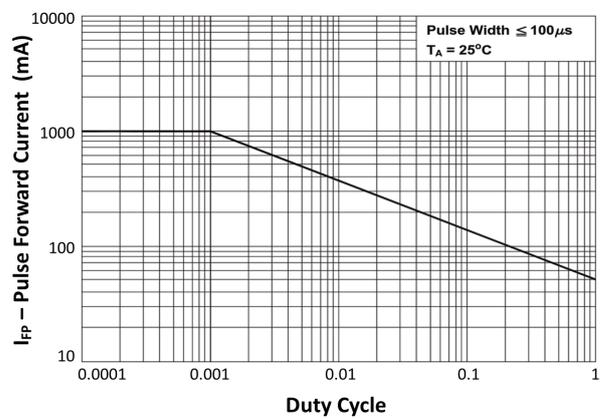


Fig 6 Pulse Forward Current vs Duty Cycle

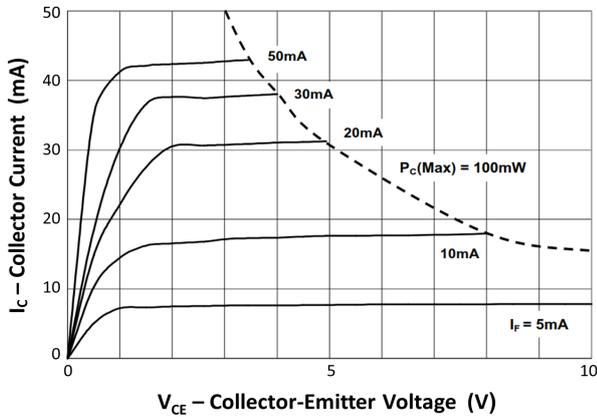


Fig 7 Collector Current vs Collector-Emitter Voltage

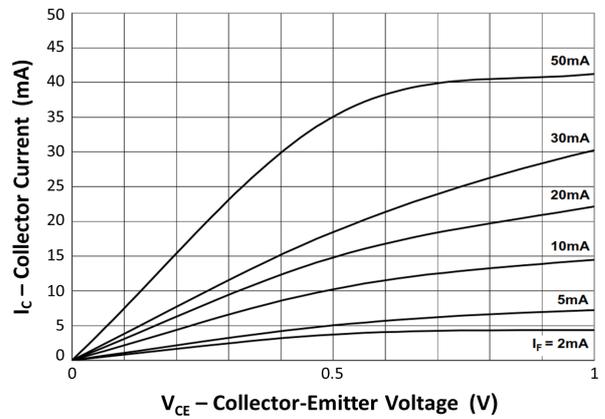


Fig 8 Collector Current vs Low Collector-Emitter Voltage

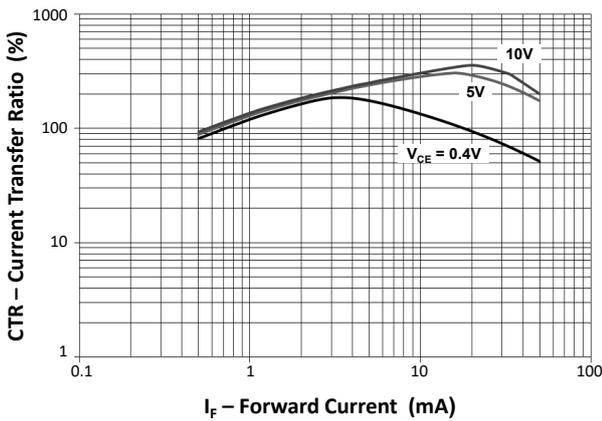


Fig 9 Current Transfer Ratio vs Forward Current

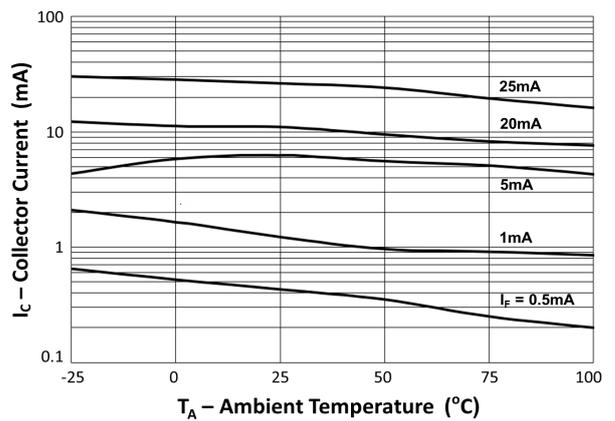


Fig 10 Collector Current vs Ambient Temperature

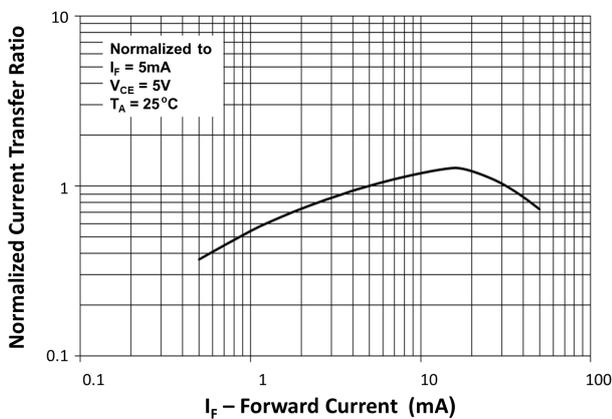


Fig 11 Normalized Current Transfer Ratio vs Forward Current

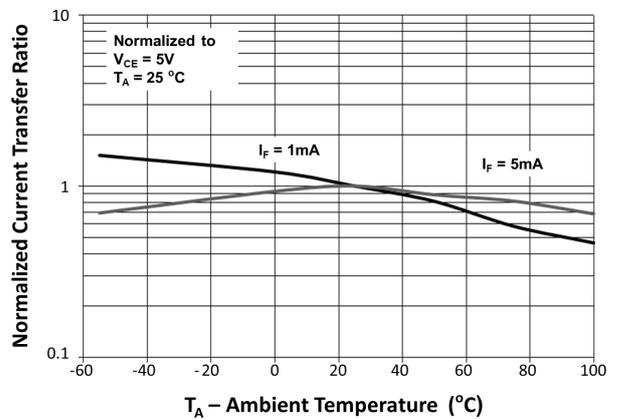


Fig 12 Normalized Current Transfer Ratio vs Ambient Temperature

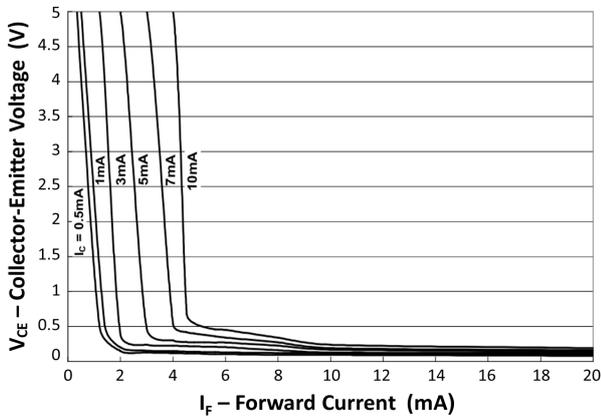


Fig 13 Collector-Emitter Voltage vs Forward Current

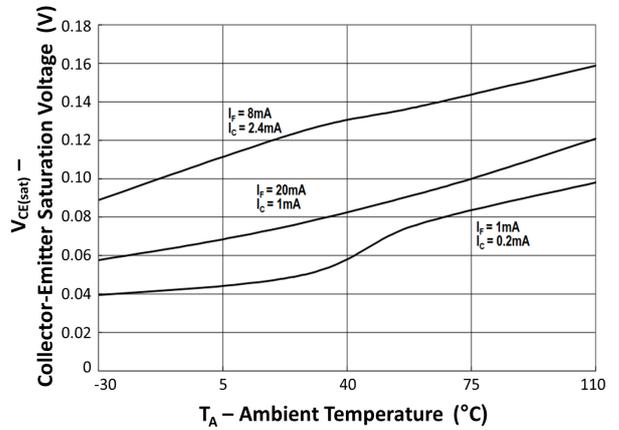


Fig 14 Collector-Emitter Saturation Voltage vs Ambient Temperature

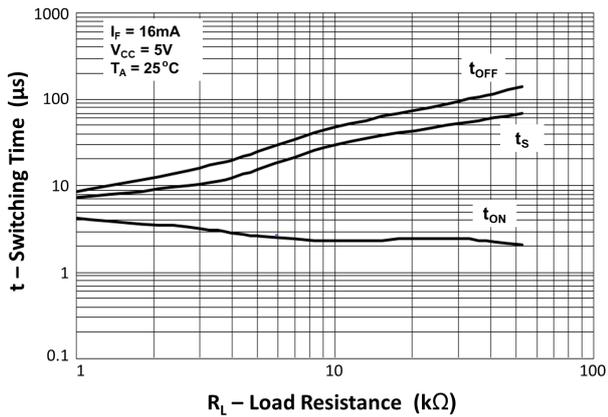


Fig 15 Switching Time vs Load Resistance

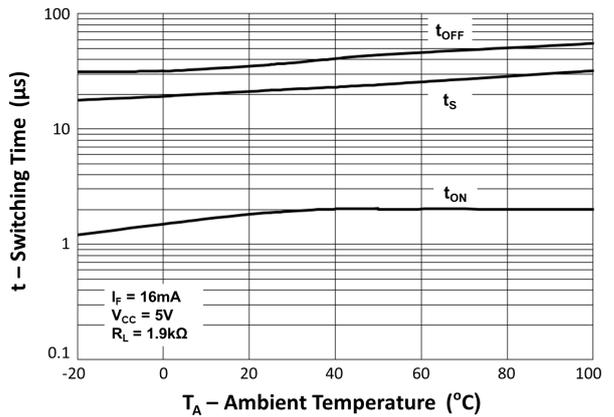


Fig 16 Switching Time vs Ambient temperature

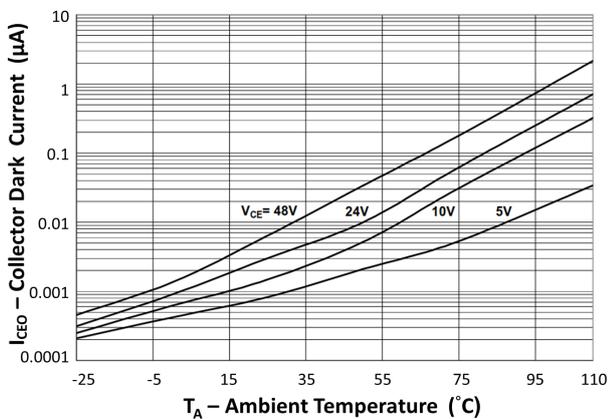


Fig 17 Collector Dark Current vs Ambient Temperature

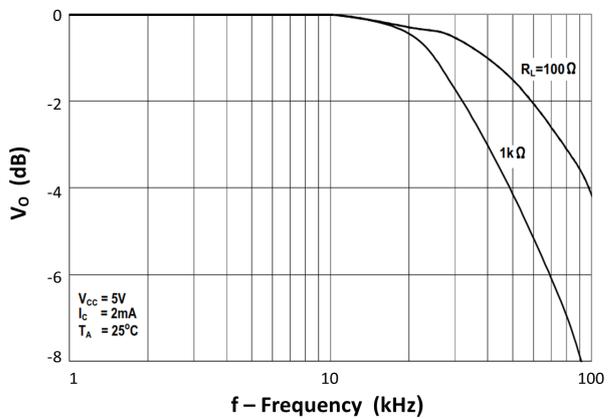
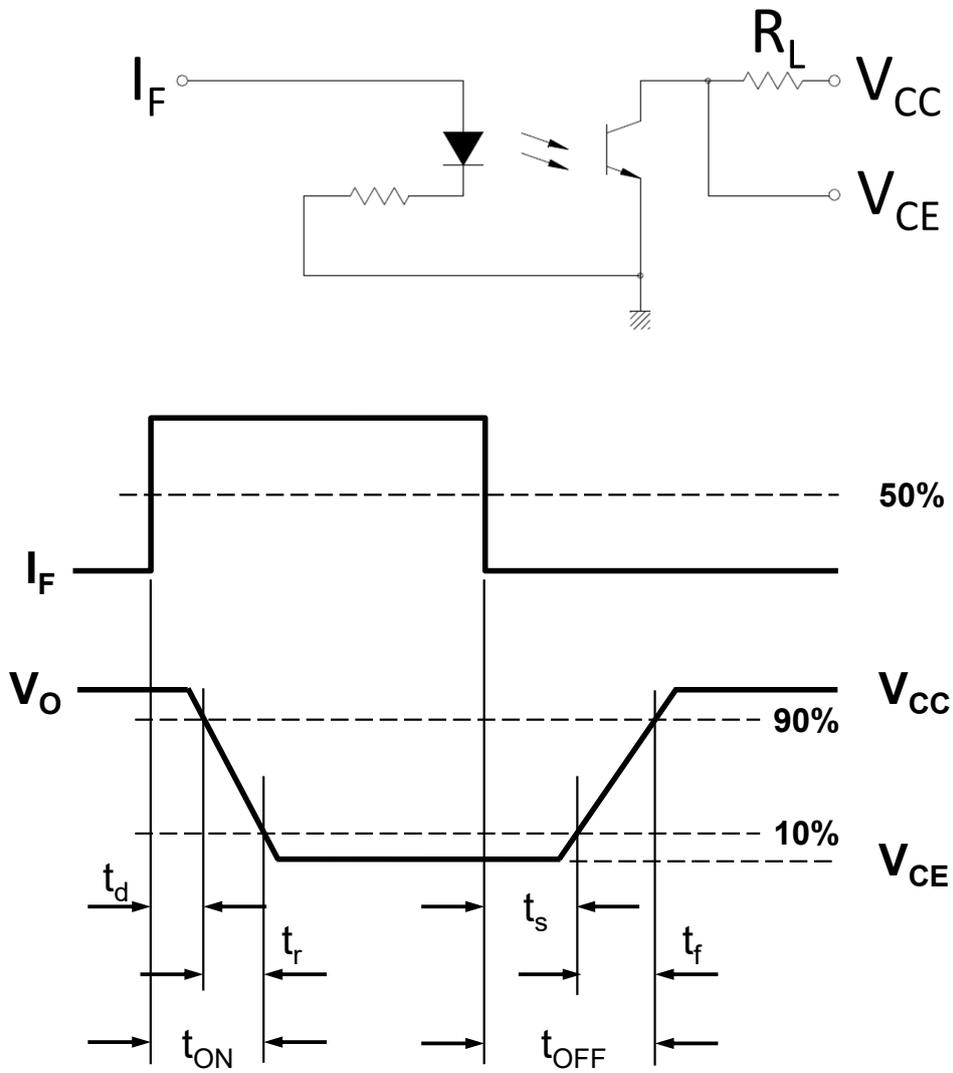


Fig 18 Frequency Response

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Switching Time Test Circuit and Waveform

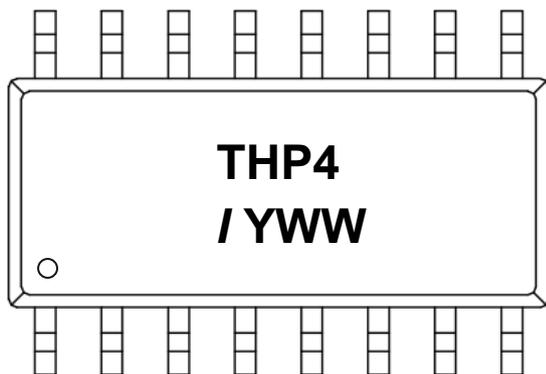
## IS281- 4, IS281- 4GB

### ORDER INFORMATION

UL Approval			
After PN	PN	Description	Packing quantity
None	IS281-4, IS281-4GB	Surface Mount Tape & Reel	2000 pcs per reel
<b>NOTE : Multiple Grades may be supplied to meet the requested specification</b>			

### DEVICE MARKING

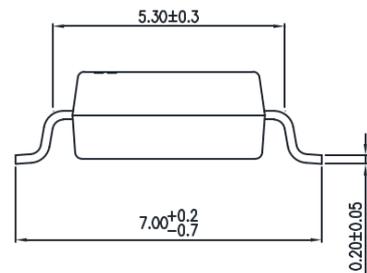
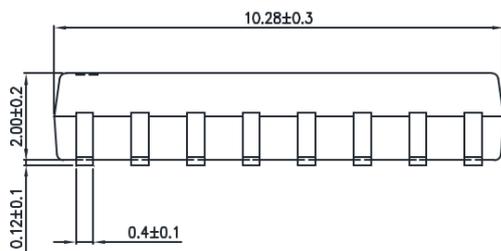
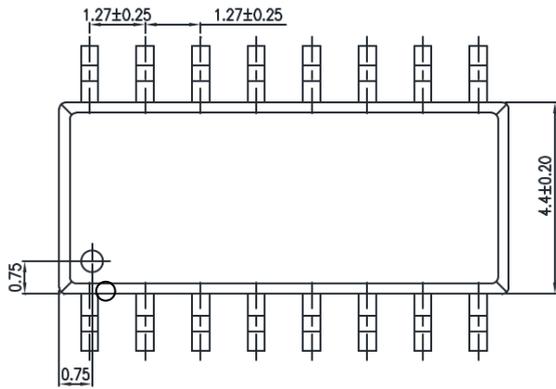
#### IS281-4GB



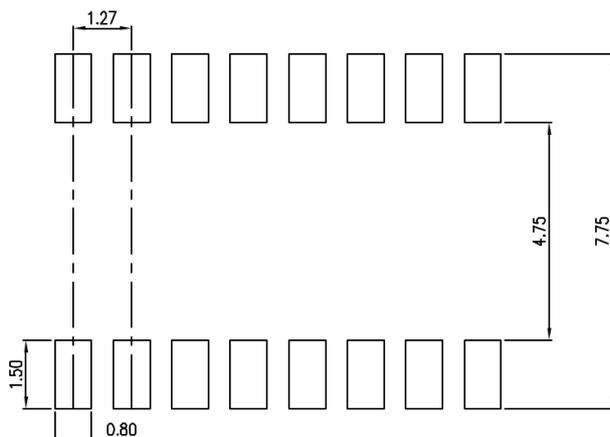
THP4      denotes Device Part Number  
 /          denotes Isocom  
 Y          denotes 1 digit Year code  
 WW        denotes 2 digit Week code

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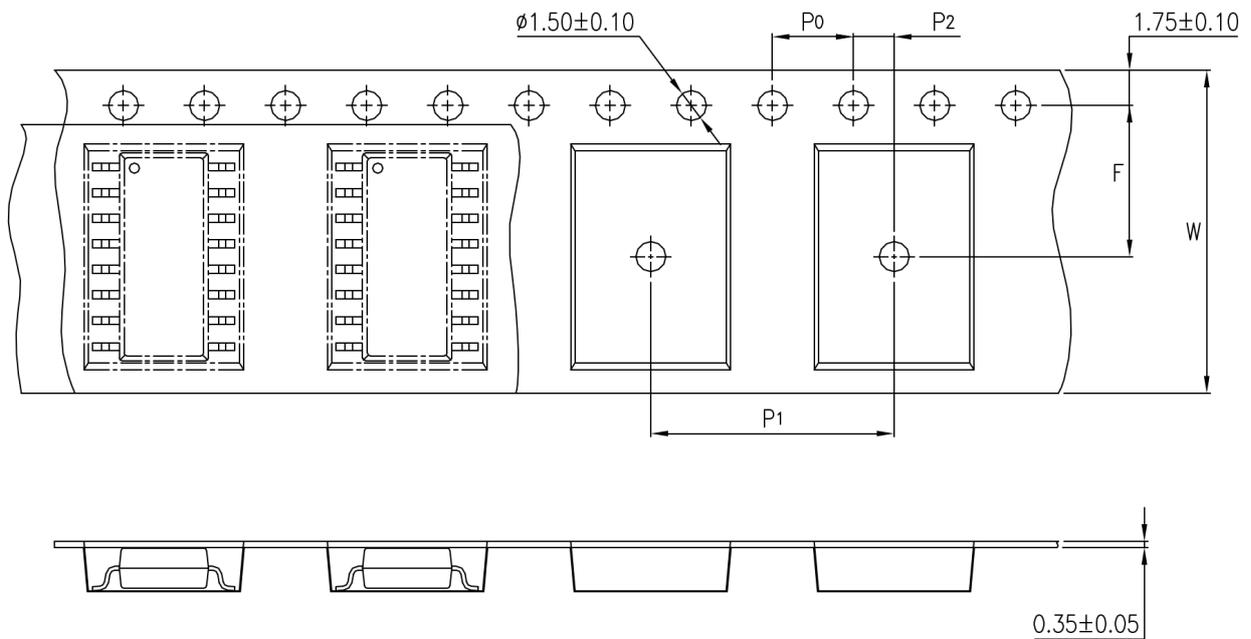
### PACKAGE DIMENSIONS (mm)



### RECOMMENDED SOLDER PAD LAYOUT (mm)



TAPE AND REEL PACKAGING

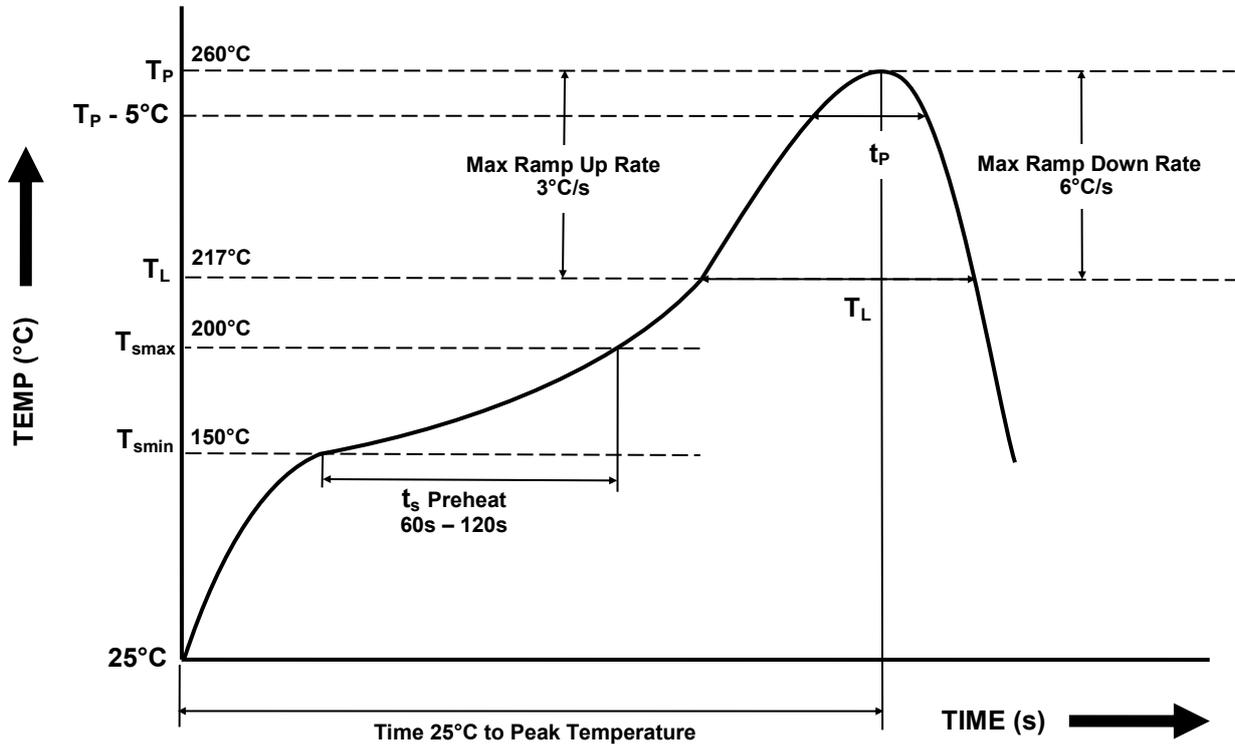


Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P <sub>0</sub>	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
	P <sub>2</sub>	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P <sub>1</sub>	12 ± 0.1 (0.47)



**IS281- 4, IS281- 4GB**

**IR REFLOW SOLDERING TEMPERATURE PROFILE**  
**One Time Reflow Soldering is Recommended.**  
**Do not immerse device body in solder paste.**



Profile Details	Conditions
<b>Preheat</b> - Min Temperature ( $T_{SMIN}$ ) - Max Temperature ( $T_{SMAX}$ ) - Time $T_{SMIN}$ to $T_{SMAX}$ ( $t_s$ )	150°C 200°C 60s - 120s
<b>Soldering Zone</b> - Peak Temperature ( $T_P$ ) - Time at Peak Temperature - Liquidous Temperature ( $T_L$ ) - Time within 5°C of Actual Peak Temperature ( $T_P - 5^\circ C$ ) - Time maintained above $T_L$ ( $t_L$ ) - Ramp Up Rate ( $T_L$ to $T_P$ ) - Ramp Down Rate ( $T_P$ to $T_L$ )	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate ( $T_{smax}$ to $T_P$ )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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